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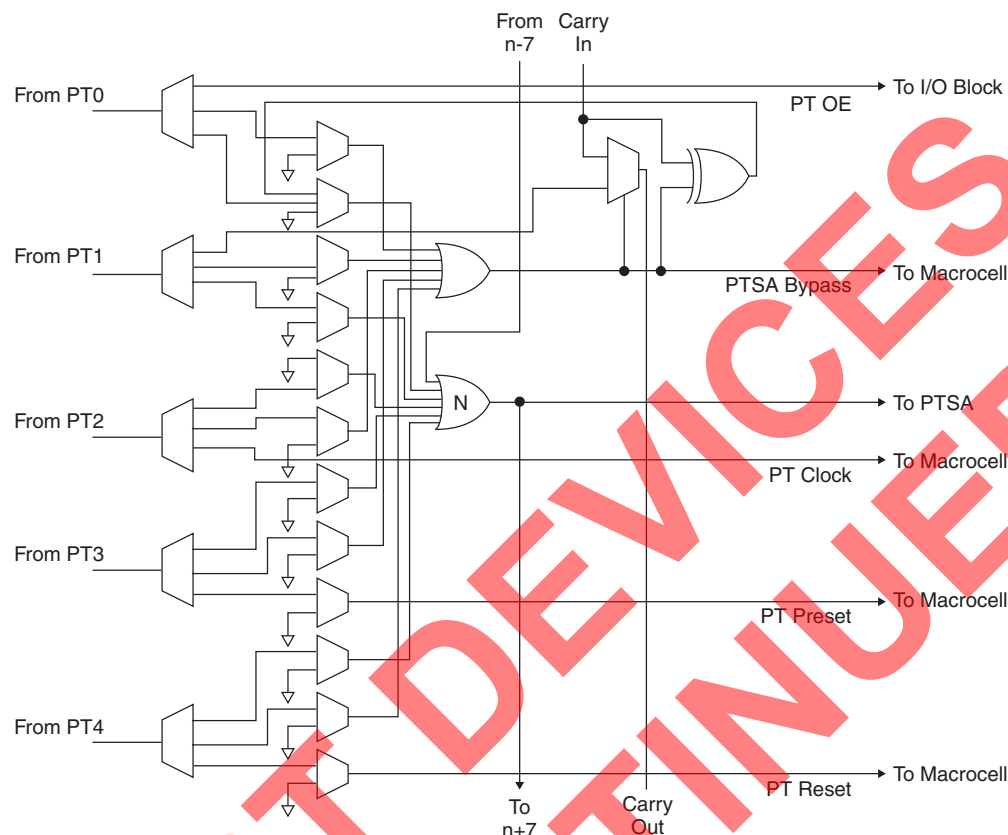
Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

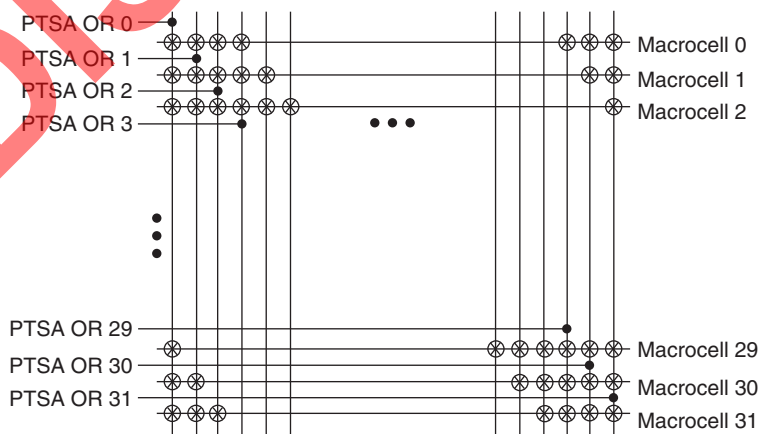
Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	16
Number of Macrocells	512
Number of Gates	-
Number of I/O	149
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5512mv-75q208c

Figure 6. Dual-OR PT Sharing Array

Product Term Sharing Array

The Product Term Sharing Array (PTSA) consists of 32 inputs from the Dual-OR Array (Expandable PTSA OR) and 32 outputs directly to the macrocells. Each output is the OR term of any combination of the seven Expandable PTSA OR terms connected to that output. Every Nth macrocell is connected to N-3, N-2, N-1, N, N+1, N+2 and N+3 PTSA OR terms via a programmable connection. This wraps around the logic, for example, Macrocell 0 gets its logic from 29, 30, 31, 0, 1, 2, 3. The Expandable PTSA OR used in conjunction with the PTSA allows wide functions to be implemented easily and efficiently. Without using the Expandable PTSA OR capability, the greatest number of product terms that can be included in a single function with one pass of delay is 35. Up to 160 product terms can be included in a single function through the use of the expandable PTSA OR capability. Figure 7 shows the graphical representation of the PTSA.

Figure 7. Product Term Sharing Array (PTSA)

Single-Port SRAM Mode

In Single-Port SRAM Mode the multi-function array is configured as a single-port SRAM. In this mode one ports accesses 16,384-bits of memory. Data widths of 1, 2, 4, 8, 16 and 32 are supported by the MFB. Figure 11 shows the block diagram of the single-port SRAM.

Write data, address, chip select and read/write signals are always synchronous (registered.) The output data signals can be synchronous or asynchronous. Reset is asynchronous. All signals share a common clock, clock enable, and reset. Table 7 shows the possible sources for the clock, clock enable and reset signals.

Figure 11. Single-Port SRAM Block Diagram

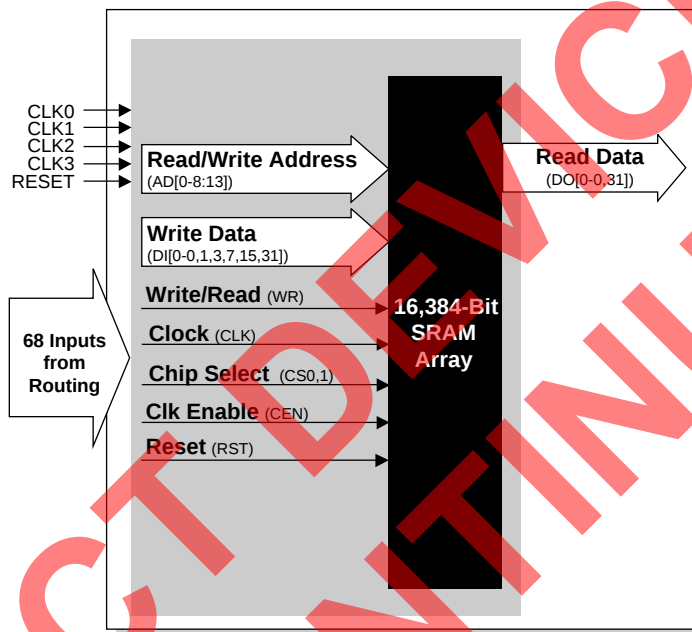


Table 7. Register Clock, Clock Enable, and Reset in Single-Port SRAM Mode

Register	Input	Source
Address, Write Data, Read Data, Read/Write, and Chip Select	Clock	CLK or one of the global clocks (CLK0 - CLK3). Each of these signals can be inverted if required.
	Clock Enable	CEN or one of the global clocks (CLK1 - CLK 2). Each of these signals can be inverted if required.
	Reset	Created by the logical OR of the global reset signal and RST. RST is routed by the multifunction array from GRP, with inversion if desired.

sysCONFIG Interface

In addition to being able to program the device through the IEEE 1532 interface a microprocessor style interface (sysCONFIG interface) allows reconfiguration of the SRAM bits within the device. For more information on the sysCONFIG capability, refer to TN1026, [ispXP Configuration Usage Guidelines](#).

Security Scheme

A programmable security scheme is provided on the ispXPLD 5000MX devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit prevents readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. The security bit also prevents programming and verification. The entire device must be erased in order to erase the security bit.

Low Power Consumption

The ispXPLD 5000MX devices use zero power non-volatile cells along with full CMOS design to provide low static power consumption. The 1.8V core reduces dynamic power consumption compared with devices with higher core voltages. For information on estimating power consumption, refer to TN1031 [Power Estimation in ispXPLD 5000MX Devices](#).

Density Migration

The ispXPLD 5000MX family has been designed to ensure that different density devices in the same package have compatible pin-outs. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

IEEE 1149.1-Compliant Boundary Scan Testability

All ispXPLD 5000MX devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal boundary scan registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for board-level testing. The test access port has its own supply voltage and can operate with LVCMOS3.3, 2.5 and 1.8V standards.

sysIO Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os' physical nature should be minimal so that board test time is minimized. The ispXPLD 5000MX family of devices allows this by offering the user the ability to quickly configure the physical nature of the sysIO cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice's ispVM™ System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}^1	Input or I/O Leakage	$0 \leq V_{IN} \leq (V_{CCO} - 0.2V)$	—	—	10	μA
		$(V_{CCO} - 0.2V) < V_{IN} \leq 3.6V$	—	—	40	μA
I_{IH}^4	Input High Leakage Current	$3.6V < V_{IN} \leq 5.5V$ and $3.0V \leq V_{CCO} \leq 3.6V$	—	—	3	mA
I_{PU}^3	I/O Active Pullup Current	$0 \leq V_{IN} \leq 0.7 V_{CCO}$	-30	—	-150	μA
I_{PD}	I/O Active Pulldown Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	150	μA
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7 V_{CCO}$	30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	150	μA
I_{BHHO}	Bus Hold High Overdrive Current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	150	μA
V_{BHT}	Bus Hold Trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{CCO} * 0.35$	—	$V_{CCO} * 0.65$	μA
C1	I/O Capacitance ²	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	8	—	pf
		$V_{CC} = 1.8V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf
C2	Clock Capacitance ²	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	8	—	pf
		$V_{CC} = 1.8V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf
C3	Global Input Capacitance ²	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	8	—	pf
		$V_{CC} = 1.8V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tristated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. T_A 25°C, $f=1.0MHz$

3. I_{PU} on JTAG pins has a maximum of -175 μA for 5512MX devices.

4. 5V tolerant inputs and I/Os should be placed in banks where $3.0V \leq V_{CCO} \leq 3.6V$. The JTAG and sysCONFIG ports are not included for the 5V tolerant interface.

Supply Current (Continued)

Symbol	Parameter	Condition	Min.	Typ. ³	Max.	Units
ispXPLD 51024						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	75	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	75	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	55	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA

1. Device configured with 16-bit counters.

2. I_{CC} varies with specific device configuration and operating frequency.3. $T_A = 25^\circ C$

ispXPLD 5000MX Family Internal Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
In/Out Delays													
t _{IN}	Input Buffer Delay	—	—	0.70	—	0.91	—	0.96	—	1.11	—	1.30	ns
t _{GCLK_IN}	Global Clock Input Buffer Delay	—	—	0.40	—	0.35	—	0.35	—	0.35	—	0.55	ns
t _{RST}	Global RESET Pin Delay	—	—	3.77	—	4.24	—	4.71	—	4.71	—	7.07	ns
t _{GOE}	Global OE Pin Delay	—	—	1.98	—	2.66	—	2.34	—	2.87	—	3.27	ns
t _{BUF}	Delay through Output Buffer	—	—	1.16	—	1.30	—	1.45	—	1.60	—	2.17	ns
t _{EN}	Output Enable Time	—	—	2.52	—	2.84	—	3.16	—	3.63	—	4.23	ns
t _{DIS}	Output Disable Time	—	—	1.92	—	2.40	—	2.40	—	2.40	—	3.60	ns
Routing Delays													
t _{ROUTE}	Delay through SRP	—	—	1.95	—	2.06	—	2.34	—	2.24	—	3.66	ns
t _{INREG}	Input Buffer to Macrocell Register Delay	—	—	0.60	—	0.60	—	0.60	—	0.47	—	1.63	ns
t _{PTSA}	Product Term Sharing Array Delay	—	—	0.50	—	0.50	—	0.53	—	0.83	—	1.34	ns
t _{FBK}	Internal Feedback Delay	—	—	0.19	—	0.02	—	0.39	—	0.03	—	0.60	ns
t _{GCLK}	Global Clock Tree Delay	—	—	0.52	—	0.32	—	0.72	—	0.82	—	0.78	ns
t _{BCLK}	Block PT Clock Delay	—	—	0.12	—	0.14	—	0.15	—	0.15	—	0.23	ns
t _{PTCLK}	Macrocell PT Clock Delay	—	—	0.12	—	0.14	—	0.15	—	0.15	—	0.23	ns
t _{PLL_DELAY}	Programmable PLL Delay Increment	—	—	0.30	—	0.30	—	0.30	—	0.30	—	0.30	ns
t _{BSR}	Block PT Reset Delay	—	—	0.72	—	0.81	—	0.90	—	0.94	—	1.35	ns
t _{PTSR}	Macrocell PT Set/Reset Delay	—	—	0.60	—	0.75	—	0.75	—	0.75	—	1.13	ns
t _{LPTOE}	Macrocell PT OE Delay	—	—	0.83	—	1.19	—	1.04	—	1.52	—	1.31	ns
t _{SPTOE}	Segment PT OE Delay	—	—	0.83	—	1.19	—	1.04	—	1.52	—	1.31	ns
t _{OSA}	Output Sharing Array Delay	—	—	0.80	—	0.90	—	1.00	—	1.00	—	1.50	ns
t _{PTOE}	Global PT OE Delay	—	—	0.83	—	1.04	—	1.04	—	1.04	—	1.56	ns
t _{PDB}	5-PT Bypass Propagation Delay	—	—	0.20	—	0.23	—	0.25	—	0.25	—	0.38	ns
t _{PDI}	Macrocell Propagation Delay	—	—	0.50	—	0.93	—	0.72	—	0.72	—	1.04	ns

ispXPLD 5000MX Family Timing Adders (Continued)

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
LVC MOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVC MOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
LVC MOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns
LVC MOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns
LVC MOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns
LVC MOS_33_4mA_out	Using 3.3V CMOS Standard, 4mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVC MOS_33_5.33mA_out	Using 3.3V CMOS Standard, 5.33mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVC MOS_33_8mA_out	Using 3.3V CMOS Standard, 8mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.8	—	0.8	—	0.8	—	0.8	—	0.8	ns
LVC MOS_33_12mA_out	Using 3.3V CMOS Standard, 12mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVC MOS_33_16mA_out	Using 3.3V CMOS Standard, 16mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVC MOS_33_20mA_out	Using 3.3V CMOS Standard, 20mA Drive	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
AGP_1X_out	Using AGP 1x Standard	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
CTT25_out	Using CTT 2.5V	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
CTT33_out	Using CTT 3.3V	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.2	—	0.2	—	0.2	—	0.2	—	0.2	ns
GTL+_out	Using GTL+	t_{IOBUF} , t_{IOEN} , t_{IODIS}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns

Power Estimation Equations

$$ICC = ICC_DC + IMFB_CPLD + IMFB_SRAM/PDPRAM/FIFO + IMFB_DPRAM + IMFB_CAM + IPLL_D$$

ICC_DC

Use the appropriate value for 5000MC (1.8V power supply) or 5000MV/B (2.5V/3.3V power supply) from the data sheet.

IMFB_CPLD

$$= ((K0 * CPLD \text{ MFB inputs} + K1 * CPLD \text{ Logical Product Terms} + K2 * CPLD \text{ GRP from MFB} + K3 * CPLD \text{ GRP from IFB}) * AF + K4) * \text{FREQ} / 1000\mu\text{A}/\text{mA}$$

IMFB_CAM

$$= \text{CAM Memory MFBs} * ((\text{FREQ} * K8) + K9) \text{ (CAM operating in typical mode)}$$

IMFB_SRAM/PDPRAM/FIFO

$$= (\text{WR_PERCENT} * (K1 + \text{WR_PERCENT} * 8 * K0 + K10 + K11) + \text{RD_PERCENT} * (K1 + 128 * \text{RD_PERCENT} * K0 + 8 * \text{OSW_PERCENT} * K2)) * \text{SRAM/PDPRAM/FIFO Memory MFBs} * \text{FREQ} / 1000\mu\text{A}/\text{mA}$$

IMFB_DPRAM

$$= (\text{WR_PERCENT} * (2 * K1 + 2 * \text{WR_PERCENT} * 8 * K0 + K10 + K11) + \text{RD_PERCENT} * (2 * K1 + 2 * 128 * \text{RD_PERCENT} * K0 + 8 * \text{OSW_PERCENT} * K2)) * \text{DPRAM Memory MFBs} * \text{FREQ} / 1000\mu\text{A}/\text{mA}$$

IPLL_D

$$= K5 * \text{PLL_FREQ} * \text{number of PLLs used. IPLD_D is the PLL digital component of the VCC supply current.}$$

Analog portion of PLL supply current consumption, from PLL power pin:

$$IPLL_A = (K6 * \text{PLL_FREQ} + K7) * \text{number of PLLs used}$$

Notes:

- ICC = Current consumption of VCC power supply (mA)
- ICC-DC = ICC DC component – Current consumption at 0Mhz (mA)
- IMFB_CPLD = CPLD (non-memory logic) current consumption (mA)
- IMFB_SRAM/PDPRAM/FIFO = Current consumption for SRAM, PDPRAM, and FIFO (mA)
- IMFB_DPRAM = Current consumption for DPRAM (mA)
- IMFB_CAM = Current consumption for CAM (mA)
- IPLD_D = PLL Current consumption of digital VCC power supply (mA)
- IPLD_A = PLL analog power pin current consumption (VCCP pin)

Signals	208 PQFP ⁴	256 fpBGA ^{3,5}	484 fpBGA, 5 ³	672 fpBGA ^{3,5}
VCC	10, 49, 76, 114, 153, 180	D4, D13, F6, F11, L6, L11, N4, N13	A17, A6, AA2, AA21, AB17, AB6, B2, B21, D19, D4, F1, F22, G10, G11, G12, G13, K16, K7, L16, L7, M16, M7, T10, T11, T12, T13, T14, T9, U1, U22, W19, W4	AA21, AA6, F21, F6, G20, G7, J13, J14, K13, K14, L13, L14, M13, M14, N10, N11, N12, N15, N16, N17, N18, N9, P10, P11, P12, P15, P16, P17, P18, P9, R13, R14, T13, T14, U13, U14, V13, V14, Y20, Y7
VCCO0	5, 17, 189, 204	A1, F7, G6	B9, C3, G8, G9, H7, J2, J7, P4	H10, H11, H8, H9, J8, J9, K8, L8, M8, N8
VCCO1	42, 57, 72	K6, L7, T1	AA9, R7, T3, T8, Y3	P8, R8, T8, U8, V8, W9, W10, W11, W8, W9
VCCO2	85, 100, 107, 121	K11, L10, T16	AA14, R16, T15, T20, Y20	P19, R19, T19, U19, V18, V19, W12, W13, W14, W15, W16, W17, W18, W19
VCCO3	146, 161, 176	A16, F10, G11	B14, C20, G14, G15, H16, J16, J21, P19	H12, H13, H14, H15, H16, H17, H18, H19, J18, J19, K19, L19, M19, N19
VCCP	136	J16	M22	N25
VCCJ	27	J1	M1	N4
GND	15, 29, 44, 81, 119, 148, 185, 7, 19, 191, 205, 40, 56, 70, 87, 101, 109, 123, 144, 160, 174	K1, C3, C14, E5, E12, G7, G8, G9, G10, H7, H8, H9, H10, J7, J8, J9, J10, K7, K8, K9, K10, M5, M12, P3	N1, A1, A2, A21, A22, AA1, AA22, AB1, AB22, B1, B22, C15, C8, D11, D12, E18, E5, F17, F6, G16, G7, H10, H11, H12, H13, H14, H15, H20, H3, H8, H9, J10, J11, J12, J13, J14, J15, J8, J9, K10, K11, K12, K13, K14, K15, K8, K9, L10, L11, L12, L13, L14, L15, L19, L4, L8, L9, M10, M11, M12, M13, M14, M19, M4, M9, N10, N11, N12, N13, N14, N9, P10, P11, P12, P13, P14, P9, R10, R11, R12, R13, R14, R15, R8, R9, T16, T7, W11, W12, Y15, Y8	A11, A16, A2, A25, AE1, AE2, AE25, AE26, AF11, AF16, AF2, AF25, B1, B2, B25, B26, J10, J11, J12, J15, J16, J17, K10, K11, K12, K15, K16, K17, K18, K9, L1, L10, L11, L12, L15, L16, L17, L18, L26, L9, M10, M11, M12, M15, M16, M17, M18, M9, N13, N14, P13, P14, R10, R11, R12, R15, R16, R17, R18, R9, T1, T10, T11, T12, T15, T16, T17, T18, T26, T9, U10, U11, U12, U15, U16, U17, U18, U9, V10, V11, V12, V15, V16, V17
GNDP	134	K16	N22	P26
NC ²	—	5256MX: A2, A11, A12, A15, B2, B12, B15, B16, C4, C12, C15, C16, D1, D11, D14, D15, D16, E1, E4, E10, E11, E13, E14, F4, F5, F12, F13, L1, L4, M3, M7, M13, N2, N6, P1, P2, P5, P6, P13, P14, P15, P16, R1, R2, R4, R5, R6, R16, T2, T3, T4, T5, T6 5512MX/5768MX: L1	5512MX: P1, AA19, AB2, AB21, J17, J6, K1, K17, K18, K19, K2, K20, K21, K22, K3, K4, K5, K6, L1, L17, L18, L2, L20, L21, L22, L3, L5, L6, M15, M17, M18, M2, M20, M21, M3, M5, M6, M8, N15, N17, N18, N19, N2, N20, N21, N3, N4, N5, N6, N8, P15, P17, P18, P2, P21, P22, P5, P6, P8, U17, U6, V18, V5, W6 5768MX/51024MX: None	A12, A13, A14, A15, AA10, AA11, AA12, AA13, AA14, AA15, AA16, AA17, AA7, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AC10, AC11, AC12, AC13, AC14, AC15, AC16, AC17, AD11, AD12, AD13, AD14, AD15, AD16, AE11, AE12, AE13, AE14, AE15, AE16, AF12, AF13, AF14, AF15, B11, B12, B13, B14, B15, B16, C11, C12, C13, C14, C15, C16, C3, D10, D11, D12, D13, D14, D15, D16, D17, E10, E11, E12, E13, E14, E15, E16, E17, E6, E7, E8, F10, F11, F12, F13, F14, F15, F16, F17, G10, G11, G12, G13, G14, G15, G16, G17, Y10, Y11, Y12, Y13, Y14, Y15, Y16, Y17

1. All grounds must be electrically connected at the board level.

2. NC pins should not be connected to any active signals, V_{CC} or GND.

3. Balls for GND, V_{CC} and V_{CCOx} are connected within the substrate to their respective common signals. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

4. Pin orientation follows the conventional counter-clockwise order from pin 1 marking of the topside view.

5. Internal GNDs and I/O GNDs (Bank 0 - Bank 3) are connected inside package. V_{CCO} balls connect to four power planes within the package, one each for V_{CCOx}.

ispXPLD 5256MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
0	61N	H30	G17	H17	H31	B1
0	61P	H28	G16	H16	H29	C1
0	62N	H26	G15	H15	H27	D3
0	62P	H24	G14	H14	H25	C2
0	63N	H22	G13	H13	H23	E3
0	63P	H21	G12	H12	-	D2
-	-	VCC	-	-	-	VCC
0	64N	H20	G11	H11	-	E2
0	64P	H18/CLK_OUT0	G10	H10	H19	F2
0	65N	H16	G9	H9	H17	F1
0	65P	H14	G8	H8	H15	G1
-	-	GND	-	-	-	GND
0	66N	H12	G7	H7	H13	F3
-	-	VCCO0	-	-	-	VCCO0
0	66P	H10	G6	H6	H11	G5
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	67N	H8	G5	H5	H9	H5
0	67P	H6/PLL_RST0	G4	H4	H7	G4
0	68N	H5	-	-	-	G3
0	68P	H4/PLL_FBK0	-	-	-	H3
0	69N	H2	-	-	H3	G2
0	69P	H0	-	-	H1	H1
-	GCLK0P	GCLK0	-	-	-	H2
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table
-	GCLK0N	GCLK1	-	-	-	J2
-	-	GND	-	-	-	GND
-	-	TDI	-	-	-	H6
-	-	TMS	-	-	-	H4
-	-	TCK	-	-	-	J6
-	-	TDO	-	-	-	K2
1	0P	A0/DATA0	A0	B0	A1	K3
1	0N	A2/DATA1	A1	B1	A3	J3
1	1P	A4/DATA2	A2	B2	-	J5
1	1N	A5/DATA3	A3	B3	-	J4
1	2P	A6/DATA4	A4	B4	A7	L2
1	2N	A8/DATA5	A5	B5	A9	M1
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
1	3P	A10/DATA6	A6	B6	A11	K4
-	-	VCCO1	-	-	-	VCCO1
1	3N	A12/DATA7	A7	B7	A13	L3
-	-	GND	-	-	-	GND
1	4P	A14/INITB	A8	B8	A15	K5

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	34N	E30	-	-	E31	H14
3	34P	E28	-	-	E29	G16
3	35N	E26	-	-	E27	G15
3	35P	E24/PLL_FBK1	-	-	E25	F15
3	36N	E22/PLL_RST1	E27	F27	E23	H12
3	36P	E21	E26	F26	-	G14
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	37N	E20	E25	F25	-	F16
-	-	VCCO3	-	-	-	VCCO3
3	37P	E18	E24	F24	E19	E16
-	-	GND	-	-	-	GND
3	38N	E16	E23	F23	E17	G13
3	38P	E14	E22	F22	E15	G12
3	39N	E12	E21	F21	E13	F14
3	39P	E10/CLK_OUT1	E20	F20	E11	E15
-	-	VCC	-	-	-	VCC
3	40N	E8	E19	F19	E9	D12
3	40P	E6	E18	F18	E7	B14
3	41N	E5	E17	F17	-	C13
3	41P	E4	E16	F16	-	A14
3	42N	E2	E31	F31	E3	A13
3	42P	E0	E30	F30	E1	B13
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
-	-	VCCO3	-	-	-	VCCO3
3	43N	F30	E15	F15	F31	B11
3	43P	F28	E14	F14	F29	C11
3	44N	F26	E13	F13	F27	B10
3	44P	F24	E12	F12	F25	A10
3	45N	F22	E11	F11	F23	C10
3	45P	F21	E10	F10	-	D10
3	46N	F20	E9	F9	-	C9
3	46P	F18	E8	F8	F19	E9
3	47N	F16/VREF3	E29	F29	F17	D9
3	47P	F14	E28	F28	F15	F9
3	48N	F12	E7	F7	F13	A9
3	48P	F10	E6	F6	F11	F8
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	49N	F8	E5	F5	F9	E8
-	-	VCCO3	-	-	-	VCCO3
3	49P	F6	E4	F4	F7	A8
3	50N	F5	E3	F3	-	B9
3	50P	F4	E2	F2	-	D8
-	-	VCC	-	-	-	VCC

ispXPLD 5512MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
0	109N	O30	O11	P18	O31	208	C4	B4
0	109P	O28	O10	P16	O29	1	E4	A4
0	110N	O26	M17	O17	O27	2	B1	B3
0	110P	O24	M16	O16	O25	3	C1	A3
0	111N	O22	M15	O15	O23	4	D3	F5
—	—	V _{CC00}	—	—	—	5	V _{CC00}	V _{CC00}
0	111P	O20	M14	O14	O21	6	C2	G6
—	—	GND (Bank 0)	—	—	—	7	GND (Bank 0)	GND (Bank 0)
0	112N	O18	M13	O13	O19	8	E3	H6
0	112P	O16	M12	O12	O17	9	D2	G5
0	113N	O14	O9	P14	O15	—	—	D3
0	113P	O12	O8	P12	O13	—	—	D2
0	114N	O10	O7	P10	O11	—	—	E4
0	114P	O8	O6	P8	O9	—	—	E3
0	115N	O6	O5	P6	O7	—	—	F4
0	115P	O4	O4	P4	O5	—	—	G4
0	116N	O2	O3	P2	O3	—	—	C2
—	—	V _{CC00}	—	—	—	—	V _{CC00}	V _{CC00}
0	116P	O0	O2	P0	O1	—	—	C1
—	—	GND (Bank 0)	—	—	—	—	GND (Bank 0)	GND (Bank 0)
0	117N	P30	O1	—	P31	—	D1	F3
0	117P	P28	O0	—	P29	—	E1	G3
0	118N	P26	O31	—	P27	—	F4	H4
—	—	V _{CC}	—	—	—	10	V _{CC}	V _{CC}
0	118P	P24	O30	—	P25	—	F5	J4
0	119N	P22	M11	O11	P23	11	E2	H5
0	119P	P20/CLK_OUT0	M10	O10	P21	12	F2	J5
0	120N	P18	M9	O9	P19	13	F1	E2
0	120P	P16	M8	O8	P17	14	G1	F2
—	—	GND	—	—	—	15	GND	GND
0	121N	P14	M7	O7	P15	16	F3	D1
—	—	V _{CC00}	—	—	—	17	V _{CC00}	V _{CC00}
0	121P	P12	M6	O6	P13	18	G5	E1
—	—	GND (Bank 0)	—	—	—	19	GND (Bank 0)	GND (Bank 0)
0	122N	P10	M5	O5	P11	20	H5	J3
0	122P	P8/PLL_RST0	M4	O4	P9	21	G4	H2
0	123N	P6	—	—	P7	22	G3	G2
0	123P	P4/PLL_FBK0	—	—	P5	23	H3	G1
0	124N	P2	—	—	P3	24	G2	H1
0	124P	P0	—	—	P1	25	H1	J1
—	GCLK0P	GCLK0	—	—	—	26	H2	N7
—	—	V _{CCJ}	—	—	—	See Power Supply and NC Connections Table		

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
—	—	V _{CCO2}	—	—	—	85	V _{CCO2}	V _{CCO2}
2	29N	E10	F5	H5	E11	86	M10	U12
—	—	GND (Bank 2)	—	—	—	87	GND (Bank 2)	GND (Bank 2)
2	30P	E12	F6	H6	E13	88	M11	AB13
2	30N	E16	F7	H7	E17	89	T13	Y13
2	31P	E18	—	—	E19	90	P11	V13
2	31N	E20/V _{REF2}	—	—	E21	91	T14	W13
2	32P	E22	F8	H8	E23	92	R12	V14
2	32N	E24	F9	H9	E25	93	R13	W14
2	33P	E26	F10	H10	E27	94	N11	Y14
2	33N	E28	F11	H11	E29	95	T15	AB14
2	34P	F0	F12	H12	F1	96	R14	AB15
2	34N	F2	F13	H13	F3	97	N12	AA15
2	35P	F4	F14	H14	F5	98	P12	U13
—	—	V _{CCO2}	—	—	—	—	V _{CCO2}	V _{CCO2}
2	35N	F6	F15	H15	F7	99	R15	U14
—	—	GND (Bank 2)	—	—	—	—	GND (Bank 2)	GND (Bank 2)
2	36P	F8	E0	—	F9	—	—	W15
2	36N	F10	E2	—	F11	—	—	W16
2	37P	F12	E4	—	F13	—	—	Y16
2	37N	F16	E6	—	F17	—	—	AA16
2	38P	F18	E8	—	F19	—	—	AB16
2	38N	F20	E10	—	F21	—	—	AA17
2	39P	F22	E12	—	F23	—	—	Y17
2	39N	F24	E16	—	F25	—	—	AA18
2	40P	F26	E20	—	F27	—	—	W17
2	40N	F28	E22	—	F29	—	—	W18
2	41P	G0	—	—	G1	—	—	V15
—	—	V _{CCO2}	—	—	—	100	V _{CCO2}	V _{CCO2}
2	41N	G2	—	—	G3	—	—	U15
—	—	GND (Bank 2)	—	—	—	101	GND (Bank 2)	GND (Bank 2)
2	42P	G4	—	—	G5	102	P13	Y18
2	42N	G6	—	—	G7	103	P15	V17
2	43P	G8	—	—	G9	—	M13	V16
2	43N	G10	—	—	G11	—	P14	U16
2	44P	G12	—	—	G13	—	—	AB18
2	44N	G14	—	—	G15	—	—	AB19
2	45P	G16	—	—	G17	—	—	U18
2	45N	G18	—	—	G19	—	—	T17
2	46P	G20	—	—	G21	104	R16	AB20
2	46N	G22	—	—	G23	105	P16	AA20
2	47P	G24	—	—	G25	106	N15	Y19
—	—	V _{CCO2}	—	—	—	107	V _{CCO2}	V _{CCO2}

ispXPLD 5512MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
3	61N	I14	I23	K23	I15	149	G13	D22
3	61P	I12	I22	K22	I13	150	G12	D21
3	62N	I10	I21	K21	I11	151	F14	J20
3	62P	I8/CLK_OUT1	I20	K20	I9	152	E15	J19
3	63N	I6	K31	—	I7	—	F12	E20
—	—	V _{CC}	—	—	—	153	VCC	VCC
3	63P	I4	K30	L30	I5	—	F13	F20
3	64N	I2	K29	L28	I3	—	D16	H17
3	64P	I0	K28	L26	I1	—	D15	H18
—	—	GND (Bank 3)	—	—	—	—	GND (Bank 3)	GND (Bank 3)
3	65N	J30	K27	—	J31	—	—	J18
—	—	V _{CCO3}	—	—	—	—	V _{CCO3}	V _{CCO3}
3	65P	J28	K26	—	J29	—	—	H19
3	66N	J26	K25	—	J27	—	—	G20
3	66P	J24	K24	—	J25	—	—	G19
3	67N	J22	K23	—	J23	—	—	C22
3	67P	J20	K22	—	J21	—	—	C21
3	68N	J18	K21	—	J19	—	—	D20
3	68P	J16	K20	—	J17	—	—	C19
3	69N	J14	K19	—	J15	—	C16	F19
3	69P	J12	K18	—	J13	—	B16	E19
—	—	GND (Bank 3)	—	—	—	—	GND (Bank 3)	GND (Bank 3)
3	70N	J10	K17	—	J11	—	C15	G18
—	—	V _{CCO3}	—	—	—	—	V _{CCO3}	V _{CCO3}
3	70P	J8	K16	—	J9	—	B15	F18
3	71N	J6	K15	—	J7	—	E14	B20
3	71P	J4	K14	—	J5	—	D14	B19
3	72N	J2	K13	—	J3	—	E13	A20
3	72P	J0	K12	—	J1	—	A15	A19
3	73N	K30	I19	K19	K31	154	D12	D18
3	73P	K28	I18	K18	K29	155	B14	C18
3	74N	K26	I17	K17	K27	156	C13	G17
3	74P	K24	I16	K16	K25	157	A14	F16
3	75N	K22	I31	K31	K23	158	A13	E17
3	75P	K21	I30	K30	—	159	B13	D17
—	—	GND (Bank 3)	—	—	—	160	GND (Bank 3)	GND (Bank 3)
3	76N	K20	K11	L21	—	—	D11	B18
—	—	V _{CCO3}	—	—	—	161	V _{CCO3}	V _{CCO3}
3	76P	K18	K10	L20	K19	—	B12	A18
3	77N	K16	K9	L18	K17	—	C12	C17
3	77P	K14	K8	L16	K15	—	E11	B17
3	78N	K12	K7	L12	K13	—	—	C16
3	78P	K10	K6	L10	K11	—	—	B16

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	143N	U22	U27	W27	U23	—	K6
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	143P	U20	U26	W26	U21	—	K3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	144N	U18	U25	W25	U19	—	K5
0	144P	U16	U24	W24	U17	—	K2
0	145N	U14	U23	W23	U15	—	L5
0	145P	U12	U22	W22	U13	—	K1
0	146N	U10	U21	W21	U11	—	L6
0	146P	U8	U20	W20	U9	—	L1
0	147N	U6	U19	W19	U7	—	M5
0	147P	U4	U18	W18	U5	—	L2
0	148N	U2	U17	W17	U3	—	N5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	148P	U0	U16	W16	U1	—	L3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	149N	W30	U15	W15	W31	—	M6
0	149P	W28	U14	W14	W29	—	M2
0	150N	W26	U13	W13	W27	—	P5
-	-	VCC	-	-	-	VCC	VCC
0	150P	W24	U12	W12	W25	—	P6
0	151N	W22	U11	W11	W23	—	M3
0	151P	W20	U10	W10	W21	—	N6
0	152N	W18	U9	W9	W19	—	N2
0	152P	W16	U8	W8	W17	—	P1
-	-	GND	-	-	-	GND	GND
0	153N	W14	U7	W7	W15	—	N3
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	153P	W12	U6	W6	W13	—	M8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	154N	W10	U5	W5	W11	—	N8
0	154P	W8	U4	W4	-	—	P2
0	155N	W6	U3	W3	W7	—	P8
0	155P	W4	U2	W2	W5	—	N4
0	156N	W2	U1	W1	W3	G2	H1
0	156P	W0	U0	W0	W1	H1	J1
-	GCLK0P	GCLK0	-	-	-	H2	N7
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table	
-	GCLK0N	GCLK1	-	-	-	J2	P7
-	-	GND	-	-	-	GND	GND
-	-	TDI	-	-	-	H6	R1
-	-	TMS	-	-	-	H4	R2

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCC	-	-	-	VCC	VCC
0	109P	Q28	Q30	S30	Q29	A7	C11
-	-	GND	-	-	-	GND	GND
0	110N	Q26	Q29	S29	Q27	D7	B11
0	110P	Q24	Q28	S28	Q25	C7	A11
0	111N	Q22	Q27	S27	Q23	B6	F11
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	111P	Q20	Q26	S26	Q21	E7	F10
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	112N	Q18	Q25	S25	Q19	E6	E10
0	112P	Q16	Q24	S24	Q17	A6	C10
0	113N	Q14/VREF0	Q3	S3	Q15	A5	D10
0	113P	Q12	Q2	S2	Q13	A4	B10
0	114N	Q10	Q23	S23	Q11	B5	A10
0	114P	Q8	Q22	S22	Q9	A3	A9
0	115N	Q6	Q21	S21	Q7	B4	C9
0	115P	Q4	Q20	S20	Q5	B3	D9
0	116N	Q2	Q19	S19	Q3	C5	F9
0	116P	Q0	Q18	S18	Q1	C6	E9
0	117N	R30	Q1	S1	R31	D5	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	117P	R28	Q0	S0	R29	D6	B8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	118N	R26	S29	-	R27	—	A7
0	118P	R24	S28	-	R25	—	B7
0	119N	R22	S27	-	R23	—	A5
0	119P	R20	S26	-	R21	—	B5
0	120N	R18	S25	-	R19	—	B6
0	120P	R16	S24	-	R17	—	C7
0	121N	R14	S23	-	R15	—	E8
0	121P	R12	S22	-	R13	—	E7
0	122N	R10	S21	-	R11	—	E6
-	-	VCC	-	-	-	VCC	VCC
0	122P	R8	S20	-	R9	—	D6
-	-	GND	-	-	-	GND	GND
0	123N	R6	S19	-	R7	—	D8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	123P	R4	S18	-	R5	—	F8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	124N	R2	S17	-	R3	—	F7
0	124P	R0	S16	-	R1	—	D7
0	125N	S30	S15	-	S31	A2	C6
0	125P	S28	S14	-	S29	B2	C5

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
1	15N	C0	A31	C31	C1	—	W5
1	16P	E30/DATA0	G0	E0	E31	W1	W1
1	16N	E28/DATA1	G1	E1	E29	Y1	Y1
1	17P	E26/DATA2	G2	E2	E27	P3	V6
1	17N	E24/DATA3	G3	E3	E25	R3	W6
1	18P	E22/DATA4	G4	E4	E23	T2	Y2
1	18N	E20/DATA5	G5	E5	E21	U2	Y3
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	19P	E18/DATA6	G6	E6	E19	V2	Y4
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	19N	E16/DATA7	G7	E7	E17	W2	Y5
-	-	GND	-	-	-	GND	GND
1	20P	E14/INITB	G8	E8	E15	R4	V7
1	20N	E12/CSB	G9	E9	E13	T4	W7
1	21P	E10/READ	G10	E10	E11	R6	AA1
1	21N	E8/CCLK	G11	E11	E9	R5	AA2
1	22P	E6	-	-	E7	U3	AA3
-	-	VCC	-	-	-	VCC	VCC
1	22N	E4	-	-	E5	V3	AA4
1	23P	E2	-	-	E3	Y2	Y6
1	23N	E0	-	-	E1	W3	AA5
1	24P	F30	H0	-	F31	U5	AB2
1	24N	F28	H2	-	F29	T5	AB3
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	25P	F26	H4	-	F27	U4	AB4
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	25N	F24	H6	-	F25	V4	AB5
1	26P	F22	H8	-	F23	AA3	AB1
1	26N	F20	H10	-	F21	AB3	AC2
1	-	F18	H12	-	F19	Y4	AC3
-	-	DONE	-	-	-	AA4	AC4
1	27P	F14	-	-	F15	AB2	AC1
1	27N	F12	-	-	F13	U6	AD1
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	28P	F10	-	-	F11	V5	AD2
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	28N	F8	-	-	F9	W6	AD3
1	29P	F6	G12	E12	F7	AB4	Y8
1	29N	F4	G13	E13	F5	AB5	Y9
1	30P	F2	G14	E14	F3	T6	AA8
1	30N	F0	G15	E15	F1	U7	AA9
-	-	PROGRAMB	-	-	-	W5	AB8
1	-	G28	H14	-	G29	U8	AB9

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	GND	-	-	-	GND	GND
2	46P	I4	J2	L2	I5	Y12	AF19
2	46N	I6	J3	L3	I7	AA13	AF20
2	47P	I8	J4	L4	I9	V12	AF21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	47N	I10	J5	L5	I11	U12	AF22
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	48P	I12	J6	L6	I13	AB13	AF23
2	48N	I14	J7	L7	I15	Y13	AF24
2	49P	I16	L0	-	I17	V13	AE17
2	49N	I18/VREF2	L1	-	I19	W13	AE18
2	50P	I20	J8	L8	I21	V14	AE19
2	50N	I22	J9	L9	I23	W14	AE20
2	51P	I24	J10	L10	I25	Y14	AE21
2	51N	I26	J11	L11	I27	AB14	AE22
2	52P	I28	J12	L12	I29	AB15	AE23
2	52N	I30	J13	L13	I31	AA15	AE24
2	53P	J0	J14	L14	J1	U13	AD17
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	53N	J2	J15	L15	J3	U14	AD18
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	54P	J4	L2	I0	J5	W15	AD19
2	54N	J6	L3	I2	J7	W16	AD20
2	55P	J8	L4	I4	J9	Y16	AD21
2	55N	J10	L5	I6	J11	AA16	AD22
2	56P	J12	L6	I8	J13	AB16	AD23
2	56N	J14	L7	I10	J15	AA17	AD24
2	57P	J16	L8	I12	J17	Y17	AC22
2	57N	J18	L9	I16	J19	AA18	AC21
2	58P	J20	L10	I20	J21	W17	AC18
-	-	VCC	-	-	-	VCC	VCC
2	58N	J22	L11	I22	J23	W18	AC19
-	-	GND	-	-	-	GND	GND
2	59P	J24	L12	-	J25	V15	AC20
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	59N	J26	L13	-	J27	U15	AB21
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	60P	J28	L14	-	J29	Y18	AB18
2	60N	J30	L15	-	J31	V17	AB19
2	61P	K0	L16	-	K1	V16	AB20
2	61N	K2	L17	-	K3	U16	AA20
2	62P	K4	L18	-	K5	AB18	AA19
2	62N	K6	L19	-	K7	AB19	Y19

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	79N	N10	P5	N5	N11	—	V26
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	80P	N12	P6	N6	N13	—	V22
2	80N	N14	P7	N7	N15	—	V23
2	81P	N16	P8	N8	N17	—	V24
2	81N	N18	P9	N9	N19	—	V25
2	82P	N20	P10	N10	N21	—	U20
2	82N	N22	P11	N11	N23	—	T20
2	83P	N24	P12	N12	N25	—	U26
2	83N	N26	P13	N13	N27	—	U25
2	84P	N28	P14	N14	N29	—	U21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	84N	N30	P15	N15	N31	—	T21
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	85P	P0	P16	N16	P1	—	U22
2	85N	P2	P17	N17	P3	—	U23
2	86P	P4	P18	N18	P5	—	U24
2	86N	P6	P19	N19	P7	—	T24
2	87P	P8	P20	N20	P9	—	T23
2	87N	P10	P21	N21	P11	—	T22
2	88P	P12	P22	N22	P13	—	T25
-	-	VCC	-	-	-	VCC	VCC
2	88N	P14	P23	N23	P15	—	R26
-	-	GND	-	-	-	GND	GND
2	89P	P16	P24	N24	P17	—	R25
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	89N	P18	P25	N25	P19	—	R24
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	90P	P20	P26	N26	P21	—	R21
2	90N	P22	P27	N27	P23	—	P21
2	91P	P24	P28	N28	P25	—	R22
2	91N	P26	P29	N29	P27	—	R23
2	92P	P28	P30	N30	P29	—	R20
2	92N	P30	P31	N31	P31	—	P20
-	-	TOE	-	-	-	W22	P25
-	-	RESET	-	-	-	V22	P24
-	-	GOE0	-	-	-	T22	P23
-	-	GOE1	-	-	-	R22	P22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	
-	GCLK3N	GCLK2	-	-	-	P16	N26
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table	

Revision History

Date	Version	Change Summary
—	—	Previous Lattice releases.
December 2003	07	Added ispXPLD 5768MX information (supply current, timings, power consumption, power estimation coefficients, memory coefficients, logic signal connections, ordering part numbers).
		Updated ispXPLD 5000MX timing numbers (version v.1.7).
		Added lead-free package designator.
		Removed ispXPLD 5000MC industrial temperature grade ordering part numbers.
January 2004	08	Lead-free package release for the ispXPLD 5000MC and 5000MV devices.
		Timing model parameter tCOi correction - Maximum specification instead of Minimum (no changes in the timing numbers).
March 2004	08.1	Updated the MFB Cascade Chain table for the ispXPLD 5256MX device.
May 2004	09	Updated the ispXPLD 5000MX timing numbers (version v.1.8)
		ispXPLD 5256MC, 5512MC and 51024MC industrial temperature grade devices release
		Updated typical supply current data and condition.
August 2004	10	ispXPLD 5256MX 256-fpBGA logic signal connection tables: Removed internal signal description for ball H5 and G14.
		Added footnote "1, page 49. These inputs should not toggle during power up for proper power-up configuration." to CCLK and READ.
October 2004	10.1	Added ispXPLD 5768MC Industrial grade OPNs (Conventional and Lead-Free).
October 2004	10.1	Figure 19, LVPECL Driver with Three Resistor Pack has been updated (ispXPLD LVPECL Buffer changed to ispXPLD Emulated LVPECL Buffer)
November 2004	11	Added ispXPLD 5000MB (2.5V) Lead-Free Ordering Part Numbers.
December 2004	11.1	Pin name RESETB has been updated to RESET.
March 2005	12	208-PQFP Lead-free package release for the ispXPLD 5512MV/B/C devices.
April 2005	12.1	Page 23, clarification of footnote regarding IDK specification.
March 2006	12.2	Signal description for RESET has been updated.
April 2009	12.3	Ordering Information section has been updated to describe alternate LC5768MB/MV top side marking format.
February 2010	12.4	References to "system gates" changed to "functional gates."